



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20251217002.2
Adding TIEM-PR as additional wafer Probe Test site
for select devices
Change Notification / Sample Request

Date: December 18, 2025
To: MOUSER PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within 60 days of the date of this notice. Lack of acknowledgement of this notice within 60 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within 60 days of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the change management team.

For sample requests or sample related questions, contact your local Field Sales Representative.

TI values customer engagement and feedback related to TI changes. Customers should contact TI if there are questions or concerns regarding a change notification.

Sincerely,

Change Management Team
SC Business Services

20251217002.2
Change Notification / Sample Request
Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TLV365QDBVRQ1	NULL
SN74AHC1G08QDCKRQ1	SN74AHC1G08QDCKRQ1

Technical details of this Product Change follow on the next page(s).

PCN Number:	20251217002.2			PCN Date:	December 18, 2025
Title:	Adding TIEM-PR as additional wafer Probe Test site for select devices				
Customer Contact:	Change Management team		Dept:	Quality Services	
Proposed 1st Ship Date:	June 16, 2026		Estimated Sample Availability:	N/A	
Change Type:					
☐	Assembly Site	☐	Design	☐	Wafer Bump Material
☐	Assembly Process	☐	Data Sheet	☐	Wafer Bump Process
☐	Assembly Materials	☐	Part number change	☐	Wafer Fab Site
☐	Mechanical Specification	☒	Test Site	☐	Wafer Fab Material
☐	Packing/Shipping/Labeling	☐	Test Process	☐	Wafer Fab Process
PCN Details					
Description of Change:					
Texas Instruments is pleased to announce TIEM-PR as additional wafer probe test site for the devices listed below to support high volume ramps.					
		Current		Additional	
Probe Test Site		TI CDAT (CD-PR)		TI Melaka (TIEM-PR)	
Test coverage, insertions, conditions will remain consistent with current testing.					
Reason for Change:					
Continuity of supply.					
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):					
Review the standard data packet for more details on these changes.					
Impact on Environmental Ratings:					
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.					
RoHS		REACH		Green Status	
☒ No Change		☒ No Change		☒ No Change	
IEC 62474					
☒ No Change					
Changes to product identification resulting from this PCN:					
None					
Product Affected:					
TLV365QDBVRQ1		SN74AHC1G08QDCKRQ1			

ZVEI ID: SEM-TF-01

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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